

10/576231

PATENT APPLICATION

Express Mail Label No.: EV 781 732 356 US
AP20 Rec'd FCTM TO 14 APR 2006

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 14, 2006

Applicants : Atsushi YABE et al

For : ELECTROLESS COPPER PLATING SOLUTION

PCT International Application No.: PCT/JP2004/011327

PCT International Filing Date: July 30, 2004

U.S. Application No.

(if known, see 37 CFR 1.5): Unknown

Atty. Docket No.: 4700.P0327US

Mail Stop PCT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT BEFORE FIRST OFFICE ACTION

Sir:

Prior to issuance of the first Office Action in the above-identified application, kindly enter the following:

(Please see following pages.)